

L Number	Hits	Search Text	DB	Time stamp
73	181	(117/98 or 117/107).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 16:12
74	8	((117/98 or 117/107).ccls.) and (atomic near2 layer near2 (deposit\$5 or epitax\$6) or ale or ald)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 16:15
75	35	((117/98 or 117/107).ccls.) and rotat\$5 near10 (gas\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 16:16
76	50	(thomas near2 omstead or karl near2 levy).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 16:17
77	3	((thomas near2 omstead or karl near2 levy).in.) and (ald or ale or atomic near2 layer near2 (deposit\$7 or epitax\$7))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 16:17
-	11832	(ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:28
-	2166	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) and (module or station)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:11
-	0	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) and (module or station) near5 plural\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:11
-	290	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) and (module or station) near5 plural\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:11
-	9	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) same (module or station) near5 plural\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:17
-	0	sequential near2 deposit\$5 near2 module	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:18
-	1	sequent\$5 near2 deposit\$5 near2 module	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:18
-	7	sequent\$5 near4 deposit\$5 near5 module	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:18
-	435	novellus.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:20

-	5	novellus.as. and ald	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:19
-	24	novellus.as. and module near5 deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 13:21
-	80	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) and module near5 deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 15:16
-	2	5879459.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 14:51
-	1374	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) and (wafer or substrate) near10 (transfer\$5 or transport\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 15:16
-	216	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) same (wafer or substrate) near10 (transfer\$5 or transport\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 15:17
-	190	((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))) same (wafer or substrate) near5 (transfer\$5 or transport\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:27
-	13	("4533410" "4951601" "5013683" "5281274" "5298452" "5310698" "5527733" "5793109" "5916365" "6048781" "6056849" "6207005" "6319553" "2002/0108714").PN.	USPAT	2004/07/30 10:02
-	3672	rotat\$5 near5 ball near5 valve	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:28
-	2132	rota\$5 near2 ball near2 valve	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:28
-	11832	(ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:28
-	2	(rota\$5 near2 ball near2 valve) and ((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:29
-	0	(rota\$5 near2 ball near2 valve) and (CVD or chemical near2 vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:30
-	0	((rota\$5 near2 ball near2 valve) and (CVD or chemical near2 vapor near2 deposit\$5)) and 117/\$.cc1s.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 11:30

-	44	(rota\$5 near2 ball near2 valve) near10 gas\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 12:05
-	70035	gas\$4 near US-20020170671-A1.DID. curtain	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 12:06
-	139	(gas\$4 near US-20020170671-A1.DID. curtain) and ((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 12:06
-	16	gas\$4 near US-20020170671-A1.DID. curtain same transfer and ((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 12:07
-	47	gas\$4 near5 curtain and ((ald or ale or atomic near2 layer near2 (deposit\$5 or epitax\$5) or sequential near2 (cvd or deposit\$5)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/30 12:07
-	108	manifold near10 showerhead and (CVD or vapor near2 deposit\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 14:18
-	32	manifold near10 showerhead same (CVD or vapor near2 deposit\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 14:37
-	3835	gas\$4 near5 curtain	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 14:38
-	268	gas\$4 near5 curtain and vapor near2 deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 14:39
-	58	gas\$4 near5 curtain same vapor near2 deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 14:43
-	22	gas\$4 near5 curtain and (vapor near2 deposit\$4) and (plural\$5 or multipl\$5) near5 (zone or station\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 14:46
-	2	6143082.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 15:48
-	489	plasma near10 (atomic near2 layer near2 (deposit\$5 or epitax\$4) or ale or ald)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 15:49
-	19	plasma near10 (atomic near2 layer near2 (deposit\$5 or epitax\$4) or ale or ald) and 117/\$4.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 15:51

-	280	plasma near10 (atomic near2 layer near2 (deposit\$5 or epitax\$4) or ale or ald) near3 (enhanc\$5 or assist\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 15:51
-	195	plasma near5 (atomic near2 layer near2 (deposit\$5 or epitax\$4) or ale or ald) near3 (enhanc\$5 or assist\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 15:52
-	110	plasma near2 (atomic near2 layer near2 (deposit\$5 or epitax\$4) or ale or ald) near3 (enhanc\$5 or assist\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 15:55
-	2	5916365.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 16:36
-	389	plasma near5 (CVD or chemical near2 vapor near2 deposit\$5 or ale or ald or atomic near2 layer near2 (deposit\$5 or epitax\$4)).ti. and bias\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 16:40
-	33	plasma near5 (CVD or chemical near2 vapor near2 deposit\$5 or ale or ald or atomic near2 layer near2 (deposit\$5 or epitax\$4)).ti. and bias\$5 near5 (susceptor or holder)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 16:55
-	6	(plasma near5 (CVD or chemical near2 vapor near2 deposit\$5 or ale or ald or atomic near2 layer near2 (deposit\$5 or epitax\$4)).ti. and bias\$5 near5 (susceptor or holder)) and showerhead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 16:38
-	23	plasma near5 (CVD or chemical near2 vapor near2 deposit\$5 or ale or ald or atomic near2 layer near2 (deposit\$5 or epitax\$4)).ti. and bias\$5 same showerhead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 16:40
-	47	plasma near5 (CVD or chemical near2 vapor near2 deposit\$5 or ale or ald or atomic near2 layer near2 (deposit\$5 or epitax\$4)).ti. and bias\$5 near10 (susceptor or holder)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 16:56
-	418	rotary near2 ball near2 valve	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:00
-	1	rotary near2 ball near2 valve and vapor near2 deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:00
-	8	rotary near2 ball near2 valve near5 (gas\$4 or vapor\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:02
-	17	rotary near5 valve same ball same deposit\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:03
-	141	rotary near5 valve same ball same (gas\$4 or vapor\$5 or vapour\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:05

-	7	rotary near5 valve same ball and vapor near2 deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:06
-	5	rotary near5 valve near5 ball and vapor near2 deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:06
-	84	rotary near5 valve near5 ball and deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:06
-	71	rotary near5 valve near5 ball same (gas\$5 or reactant\$5 or precursor\$5 or vapor\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/12 17:07
-	201	gas\$5 near2 curtain near10 (separat\$5 or isolat\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/13 15:56
-	107	gas\$5 near2 curtain near10 (separat\$5 or isolat\$6) same chamber	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/13 16:24
-	24	inert near5 gas\$5 near2 curtain near10 (separat\$5 or isolat\$6) same chamber	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/13 16:26
-	949406	inert near5 gas\$5 near2 curtain and cluster enar5 tool	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/13 16:27
-	1	inert near5 gas\$5 near2 curtain and cluster near5 tool	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/13 16:27
-	0	inert near5 gas\$5 near2 curtain same cluster	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/13 16:27
-	26	inert near5 gas\$5 near2 curtain and cluster	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/13 16:28
-	75	inert near5 gas\$5 near2 curtain same deposit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 10:47
-	3396	(wafer or substrate) near10 bias\$5 and plasma near2 (CVD or vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 10:56
-	626	(wafer or substrate) near10 bias\$5 same plasma near2 (CVD or vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 10:56

-	513	(wafer or substrate) near5 bias\$5 same plasma near2 (CVD or vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 10:56
-	341	(wafer or substrate) near2 bias\$5 same plasma near2 (CVD or vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 11:02
-	0	(wafer or substrate) near2 bias\$5 same plasma near2 (CVD or vapor near2 deposit\$5) and plasma.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 11:02
-	93	(wafer or substrate) near2 bias\$5 same plasma near2 (CVD or vapor near2 deposit\$5) and plasma.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 11:15
-	1	(wafer or substrate) near2 bias\$5 near10 advantag\$5 same plasma near2 (CVD or vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2004/08/16 11:15
-	33653	(wafer or substrate) near2 bias\$5 near10 improv\$6 same plasma near2 (CVD or vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2004/08/16 11:16
-	9	(wafer or substrate) near2 bias\$5 near10 improv\$6 same plasma near2 (CVD or vapor near2 deposit\$5)	USPAT; US-PGPUB; EPO; DERWENT; IBM_TDB	2004/08/16 11:30
-	1	5879459.pn. and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:16
-	0	plasma near5 clean\$5 same substrate near5 bias\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 11:34
-	139	plasma near5 clean\$5 same substrate near5 bias\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 11:37
-	0	plasma near5 clean\$5 same substrate near5 bias\$5 and (ald or ale or atomic near2 layer near2 (epitax\$5 or deposit\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 11:37
-	387	plasma near2 etch\$5 same substrate near2 bias\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:17
-	75	plasma near2 etch\$5 near5 substrate near2 bias\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:18
-	12	plasma near2 clean\$5 near5 substrate near2 bias\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:18

-	60	substrate near2 bias\$5 near10 plasma and showerhead near10 plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:51
-	450	cluster near5 tool same plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:51
-	131	cluster near5 tool same plasma and plasma near10 bias\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:51
-	64	cluster near5 tool same plasma and plasma near10 bias\$5 near10 (wafer or substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:54
-	149	cluster same plasma and plasma near10 bias\$5 near10 (wafer or substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 13:57
-	38	(US-4545136-\$ or US-6040021-\$ or US-5125360-\$ or US-4763602-\$ or US-6444277-\$ or US-6635965-\$ or US-6541353-\$ or US-6143082-\$ or US-6387185-\$ or US-5997588-\$ or US-5351706-\$ or US-5102098-\$ or US-5656338-\$ or US-6042652-\$ or US-6174377-\$ or US-5879459-\$ or US-6136725-\$ or US-6296711-\$ or US-5866213-\$ or US-5251148-\$ or US-6056824-\$).did. or (US-20030141820-\$ or US-20040038529-\$ or US-20040065258-\$ or US-20030232506-\$ or US-20020170671-\$ or US-20030109094-\$ or US-20020108714-\$ or US-20040005753-\$ or US-20020100418-\$ or US-20020195056-\$ or US-20010013313-\$ or US-20010011526-\$ or US-20010016364-\$ or US-20040023516-\$ or US-20030198587-\$ or US-20010007244-\$ or US-20020046705-\$).did.	USPAT; US-PGPUB	2004/08/16 13:55
-	15	((US-4545136-\$ or US-6040021-\$ or US-5125360-\$ or US-4763602-\$ or US-6444277-\$ or US-6635965-\$ or US-6541353-\$ or US-6143082-\$ or US-6387185-\$ or US-5997588-\$ or US-5351706-\$ or US-5102098-\$ or US-5656338-\$ or US-6042652-\$ or US-6174377-\$ or US-5879459-\$ or US-6136725-\$ or US-6296711-\$ or US-5866213-\$ or US-5251148-\$ or US-6056824-\$).did. or (US-20030141820-\$ or US-20040038529-\$ or US-20040065258-\$ or US-20030232506-\$ or US-20020170671-\$ or US-20030109094-\$ or US-20020108714-\$ or US-20040005753-\$ or US-20020100418-\$ or US-20020195056-\$ or US-20010013313-\$ or US-20010011526-\$ or US-20010016364-\$ or US-20040023516-\$ or US-20030198587-\$ or US-20010007244-\$ or US-20020046705-\$).did.) and cluster	USPAT; US-PGPUB	2004/08/16 13:55

-	14	((US-4545136-\$ or US-6040021-\$ or US-5125360-\$ or US-4763602-\$ or US-6444277-\$ or US-6635965-\$ or US-6541353-\$ or US-6143082-\$ or US-6387185-\$ or US-5997588-\$ or US-5351706-\$ or US-5102098-\$ or US-5656338-\$ or US-6042652-\$ or US-6174377-\$ or US-5879459-\$ or US-6136725-\$ or US-6296711-\$ or US-5866213-\$ or US-5251148-\$ or US-6056824-\$).did. or (US-20030141820-\$ or US-20040038529-\$ or US-20040065258-\$ or US-20030232506-\$ or US-20020170671-\$ or US-20030109094-\$ or US-20020108714-\$ or US-20040005753-\$ or US-20020100418-\$ or US-20020195056-\$ or US-20010013313-\$ or US-20010011526-\$ or US-20010016364-\$ or US-20040023516-\$ or US-20030198587-\$ or US-20010007244-\$ or US-20020046705-\$).did.) and cluster and plasma	USPAT; US-PGPUB	2004/08/16 13:55
-	3	((US-4545136-\$ or US-6040021-\$ or US-5125360-\$ or US-4763602-\$ or US-6444277-\$ or US-6635965-\$ or US-6541353-\$ or US-6143082-\$ or US-6387185-\$ or US-5997588-\$ or US-5351706-\$ or US-5102098-\$ or US-5656338-\$ or US-6042652-\$ or US-6174377-\$ or US-5879459-\$ or US-6136725-\$ or US-6296711-\$ or US-5866213-\$ or US-5251148-\$ or US-6056824-\$).did. or (US-20030141820-\$ or US-20040038529-\$ or US-20040065258-\$ or US-20030232506-\$ or US-20020170671-\$ or US-20030109094-\$ or US-20020108714-\$ or US-20040005753-\$ or US-20020100418-\$ or US-20020195056-\$ or US-20010013313-\$ or US-20010011526-\$ or US-20010016364-\$ or US-20040023516-\$ or US-20030198587-\$ or US-20010007244-\$ or US-20020046705-\$).did.) and cluster same plasma	USPAT; US-PGPUB	2004/08/16 13:55
-	138	cluster near5 tool and plasma near10 bias\$5 near10 (wafer or substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 16:33
-	368	gas\$5 near5 distribut\$5 near10 reactors!	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 16:34
-	107	gas\$5 near5 distribut\$5 near10 reactor near5 plurality	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 16:35
-	64	gas\$5 near5 distribut\$5 near10 reactor near plurality	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 16:55
-	19	showerhead near10 (triangular or delta or linear)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 16:57
-	1	showerhead near10 (triangular or delta)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/16 16:58

-	175	showerhead near10 shap\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/16 16:58
-	56	showerhead near10 shap\$5 near10 (gas\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/16 16:58